ASOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES INTO A CONNECTING International and Pan-American	ekburn, Illinois, A	Il rights reserved ur ntions.	nder both le	his docume vel parts, t	ent is a declaration en declaration	on of the substan	ces within the manufactur ower level materials for w	rer listed ite which the ma	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and				ials and Mf	and Mfg Information			
Supplier Information												
Company name*	any name* Company unique ID			Unique ID Authority				Response Date*				
onsemi									2024-04-23			
Contact Name	Title - Contact			]	Phone - Contact*			Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	norized Representative* Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr I	em Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Veight*	UOM	Unit Type	
AMIS	S30624C6244G I2C 800MA STEPF		PER DRIVER		2024-04-23		PHG	6	12.57	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Terminal Base Alloy J-		-STD-020 MSL R	Rating	Peak Process Body Temperature		ature Max Time at Peak	Temperature Number of Reflow Cycles		les		
Matte Tin (Sn) - annealed CU Alloy 2				260	С	30	second	ls 3				
Comments												
ATTENTION: MSL 2 Rated item requires Dry Pac	x (after electrical	test)										
for more information regarding material compositi	on please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).								
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	35.93	mg	Supplier	Silicon (Si)	7440-21-3		35.93	mg
Die Attach	6.55	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		1.5065	mg
			Supplier	Silver (Ag)	7440-22-4		5.0435	mg
Lead Frame 188	188.57	mg	Supplier	Zinc (Zn)	7440-66-6		0.1886	mg
			Supplier	Iron (Fe)	7439-89-6		4.3371	mg
			Supplier	Copper (Cu)	7440-50-8		183.8558	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1886	mg
Mold Compound-Black	377.0	mg		Epoxy Phenol Resin	proprietary data		39.585	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		337.415	mg
Plating	3.7	mg	Supplier	Tin (Sn)	7440-31-5		3.7	mg
Wire Bond - Au	0.82	mg	Supplier	Gold (Au)	7440-57-5		0.82	mg